



(社)日本半導体製造装置協会

東京都千代田区六番町 3
番地六番町SKビル6F
Web <http://www.seaj.or.jp>

2008年6月度BBレシオ (Book-to-Bill) (SEAJ速報値) 日本製半導体製造装置 (3ヶ月平均)

注意: データは3ヵ月移動平均です。

次回予定: SEAJ 7月度BBレシオ 8/19 16:00 SEAJ ホームページアップ予定

日本製の半導体製造装置の2008年6月度のBBレシオは0.99

東京 2008年7月23日 - 日本半導体製造装置協会が23日に発表した6月度の半導体製造装置速報値によると日本製装置(輸出を含む)の受注額は**87,551**百万円(3ヶ月移動平均)、BBレシオは**0.99**だった。BBレシオ0.99は100円で販売したのに対し99円の新たな受注があったということを示す。

受注額は前月比**11.9%**減(2008年5月度確定値は**99,346**百万円)、前年同月比**43.7%**減(2007年6月度は**155,546**百万円)の**87,551**百万円だった。

販売額は前月比**29.4%**減(2008年5月度確定値は**125,045**百万円)、前年同月比**41.9%**減(2007年6月度は**151,834**百万円)の**88,283**百万円だった。

※BBレシオの算出に当たっては、受注高、販売高の3ヶ月移動平均データを使用。単位:百万円

	販売 (3ヶ月平均)	受注 (3ヶ月平均)	BBレシオ
2008/1	138,219	126,424	0.91
2008/2	132,322	112,493	0.85
2008/3	154,842	113,471	0.73
2008/4	137,316	104,748	0.76
2008/5(確定値)	125,045	99,346	0.79
2008/6(暫定値)	88,283	87,551	0.99

本データは速報値(3ヶ月移動平均)です。確定値とは多少差異が生じる場合がありますのでご利用に際してはご注意ください。

なおSEMIは北米製の半導体製造装置のBBレシオ(3ヶ月移動平均の受注・販売比率)の速報を発表しています。

Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

お問い合わせ先 :

事務局 広報部長 小林 正道(こばやし まさみち)

Web <http://www.seaj.or.jp> E-mail kobayashi@seaj.or.jp



June 2008 Book-to-Bill Ratio (Express Report)

Japan-based Semiconductor Manufacturing Equipment (3 Month Average)

Note : All data is based on three month average numbers.

Mark your calendars. **The July Report SEAJ's Web site update** is scheduled on **Tuesday, 19th August.** approximately 4:00.P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts June 2008 Book-to-Bill Ratio of 0.99

Tokyo Japan., **July 23, 2008** -- JAPAN-based manufacturers of semiconductor equipment posted **¥ 87,551 million** in orders in **June 2008** (three-month average basis) and a BB Ratio of **0.99** according to the **June 2008** BB Ratio published today by SEAJ. A book-to-bill ratio of **0.99** means that **¥ 99** worth of new orders was received for every ¥100 of product billed for the month.

The three-month average of worldwide bookings in **June 2008** was **¥ 87,551 million**. The bookings figure is **11.9percent down the final May 2008** level of **¥ 99,346 million** and **43.7 percent down the ¥ 155,546 million** in orders posted in **June 2007**.

The three-month average of worldwide billings in **June 2008** was **¥88,283 million**. The billings figure is **29.4percent down the final May 2008** level of **¥ 125,045 million** and **41.9 percent down the June 2007** billings level of **¥ 151,834 million**. The SEAJ book-to-bill is a ratio of three-month moving average bookings to three-month moving average billings for the Japanese semiconductor equipment industry. Billings and bookings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Bookings (Three-month avg.)	Book-to-Bill Ratio
January 2008	138,219	126,424	0.91
February 2008	132,322	112,493	0.85
March 2008	154,842	113,471	0.73
April 2008	137,316	104,748	0.76
May 2008(final)	125,045	99,346	0.79
June 2008(prelim)	88,283	87,551	0.99

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Book-to-Bill Ratio published by SEAJ that tracks billings and bookings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings and orders of the chips themselves.

SEMI is released North American Semiconductor Manufacturing Equipment /Book-to-Bill Ratio(3 months Average) on Website. Web http://wps2a.semi.org/wps/portal/_pagr/135/_pa.135/677f

CONTACT : Masamichi Kobayashi General Manager of Public Relations Department SEAJ
Web <http://www.seaj.or.jp> E-mail kobayashi@seaj.or.jp